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TRANSMITTAL FORM <i>(to be used for all correspondence after initial filing)</i>	Application Number	09/420,086
	Filing Date	10/18/99
	First Named Inventor	FARNWORTH et al.
	Group Art Unit	2811
	Examiner Name	PAREKH, N.
Total Number of Pages in This Submission	Attorney Docket Number 98-0105.1	

ENCLOSURES (check all that apply)		
<input type="checkbox"/> Fee Transmittal Form <input type="checkbox"/> Fee Attached <input checked="" type="checkbox"/> Amendment / Reply <input type="checkbox"/> After Final <input type="checkbox"/> Affidavits/declaration(s) <input type="checkbox"/> Extension of Time Request <input type="checkbox"/> Express Abandonment Request <input type="checkbox"/> Information Disclosure Statement <input type="checkbox"/> Certified Copy of Priority Document(s) <input type="checkbox"/> Response to Missing Parts/Incomplete Application <input type="checkbox"/> Response to Missing Parts under 37 CFR 1.52 or 1.53	<input type="checkbox"/> Assignment Papers (for an Application) <input type="checkbox"/> Drawing(s) <input type="checkbox"/> Licensing-related Papers <input type="checkbox"/> Petition <input type="checkbox"/> Petition to Convert to a Provisional Application <input type="checkbox"/> Power of Attorney, Revocation Change of Correspondence Address <input type="checkbox"/> Terminal Disclaimer <input type="checkbox"/> Request for Refund <input type="checkbox"/> CD, Number of CD(s) _____	<input type="checkbox"/> After Allowance Communication to Group <input type="checkbox"/> Appeal Communication to Board of Appeals and Interferences <input type="checkbox"/> Appeal Communication to Group (Appeal Notice, Brief, Reply Brief) <input type="checkbox"/> Proprietary Information <input type="checkbox"/> Status Letter <input checked="" type="checkbox"/> Other Enclosure(s) (please identify below): Return receipt postcard
Remarks: Enclosed for filing is an Amendment in response to the Office Action dated January 8, 2001 having a statutory period for response set to expire on April 9, 2001.		

SIGNATURE OF APPLICANT, ATTORNEY, OR AGENT	
Firm or Individual name	Stephen A. Gratton THE LAW OFFICE OF STEPHEN A. GRATTON
Signature	
Date	April 9, 2001

CERTIFICATE OF MAILING			
I hereby certify that this correspondence is being deposited with the United States Postal Service with sufficient postage as first class mail in an envelope addressed to: Commissioner for Patents, Washington, DC 20231 on this date: 4/9/01			
Typed or printed name	Stephen A. Gratton		
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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

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In re application of:

TC 2800 MAIL ROOM

WARREN M. FARNWORTH
ALAN G. WOOD

Serial No. 09/420,086

Art Unit: 2811

Filing Date: October 18, 1999

Examiner: PAREKH, N.

For: METHOD FOR FABRICATING
SEMICONDUCTOR COMPONENTS

Attorney Docket No. 98-0105.01

9/B
4-17-01
T. Flowers

AMENDMENT

APRIL 9, 2001

Assistant Commissioner of Patents
BOX AMENDMENT (NON FEE)
Washington, D.C. 20231

Sir:

In response to the Office Action dated January 8, 2001 having a statutory period for response set to expire on April 9, 2001, please amend the captioned case as follows.

In the Specification

Please delete lines 12-20 on page 17, and replace with the following clean replacement paragraph:

--The interconnect 84 can be constructed substantially as disclosed in U.S. Patent No. 5,686,317 entitled "Method For Forming An Interconnect Having A Penetration Limited Contact Structure For Establishing A Temporary Electrical Connection With A Semiconductor Die", which is incorporated herein by reference. U.S. Patent Application No. 08/993,965, now U.S. Patent No. 6,107,109, entitled "Semiconductor Interconnect Having Laser Machined Contacts", which is incorporated herein by reference, also describes a method for fabricating the interconnect 84.--

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